

General Description

The 150N03 is N-ch MOSFETs with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

Features

- Simple Drive Requirement
 - Fast Switching
 - Low On-Resistance

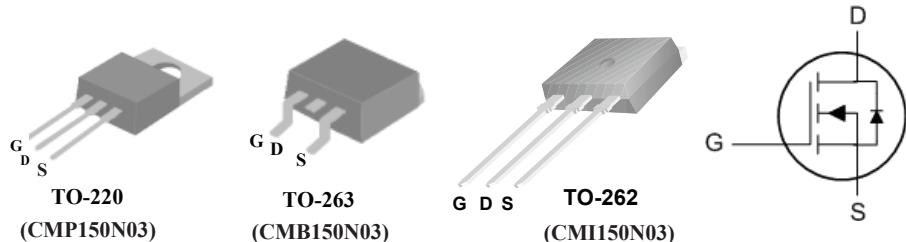
Product Summary

BVDSS	RDS(on)	ID
30V	4.5mΩ	120A

Applications

- HIGH CURRENT, HIGH SPEED SWITCHING
 - DC-DC & DC-AC CONVERTERS
 - MOTOR CONTROL, AUDIO AMPLIFIERS
 - SOLENOID AND RELAY DRIVERS
 - AUTOMOTIVE ENVIRONMENT

TO220 / TO263 / TO262 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_C = 25^\circ\text{C}$	Continuous Drain Current ¹	120	A
I_{DM}	Pulsed Drain Current ²	360	A
EAS	Single Pulse Avalanche Energy ³	720	mJ
P_D	Total Power Dissipation	250	W
T_{STG}	Storage Temperature Range	-55 to 175	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 175	$^\circ\text{C}$

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	---	62.5	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-case	---	0.5	°C/W

N-Channel Enhancement Mode Field Effect Transistor
Electrical Characteristics ($T_j=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=250\mu\text{A}$	30	---	---	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}$, $I_D=50\text{A}$	---	---	4.5	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$, $I_D=250\mu\text{A}$	1	---	3	V
I_{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}=30\text{V}$, $V_{\text{GS}}=0\text{V}$	---	---	1	uA
		$V_{\text{DS}}=30\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_C=125^\circ\text{C}$	---	---	10	
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
g_{fs}	Forward Transconductance ⁴	$V_{\text{DS}}=15\text{V}$, $I_D=50\text{A}$	---	150	---	S
Q_g	Total Gate Charge	$I_D=120\text{A}$	---	95	135	nC
Q_{gs}	Gate-Source Charge	$V_{\text{DD}}=24\text{V}$	---	28	---	
Q_{gd}	Gate-Drain Charge	$V_{\text{GS}}=10\text{V}$	---	35	---	
$T_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DD}}=15\text{V}$	---	30	---	ns
T_r	Rise Time	$I_D=60\text{A}$	---	208	---	
$T_{\text{d(off)}}$	Turn-Off Delay Time	$R_G=4.7\ \Omega$	---	82	---	
T_f	Fall Time	$V_{\text{GS}}=10\text{V}$	---	45	---	
C_{iss}	Input Capacitance	$V_{\text{DS}}=25\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	4600	---	pF
C_{oss}	Output Capacitance		---	980	---	
C_{rss}	Reverse Transfer Capacitance		---	115	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$V_G=V_D=0\text{V}$, Force Current	---	---	120	A
I_{SM}	Pulsed Source Current ²		---	---	360	A
V_{SD}	Diode Forward Voltage ⁴	$V_{\text{GS}}=0\text{V}$, $I_s=120\text{A}$	---	---	1.3	V

Note :

- 1.Current Limited by Package
- 2.Pulse width limited by safe operating area
- 3.Starting $T_j = 25^\circ\text{C}$, $I_d = 60\text{A}$, $V_{\text{DD}}=30\text{ V}$
- 4.Pulsed: pulse duration=300μs, duty cycle 1.5%